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OCT 25 2004 U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OF CE ATHY DOCKET NO. SERIAL NO. Form PTO 1449 (Modified) 2484.12US99DIV 10/767,998 APPLICANT LIST OF REFERENCES CITED BY APPLICANT Jamal RAMDANI, et al. FILING DATE **GROUP** February 2, 2004 2815 U.S. PATENT DOCUMENTS **EXAMINER** DOCUMENT DATE NAME CLASS SUB FILING DATE CLASS IF APPROPRIATE NITIAL NUMBER 3,802,967 04/09/74 Ladany et al. AB 4,174,422 11/13/79 Matthews et al. 4,404,265 09/13/83 Manasevit AC 11/13/84 Hovel et al. ΑD 4,482,906 06/11/85 Morimoto et al. AΕ 4,523,211 04/28/87 Manasevit AF 4,661,176 Meunier et al. AG 4,793,872 12/27/88 4,846,926 07/11/89 Kay et al. AH 4,855,249 08/08/89 Akasaki et al. 4,891,091 01/02/90 Shastry 4,912,087 03/27/90 Aslam et al. AK 05/22/90 Umeno et al. AL 4,928,154 Wanlass et al. ΑМ 4,963,949 10/16/90 ΑÑ 5,141,894 08/25/92 Bisaro et al. 10/27/92 Calviello et al. AO 5,159,413 AΡ 5,173,474 12/22/92 Connell et al. 5,221,367 06/22/93 Chisholm et al. AQ 07/06/93 McKee et al. 5,225,031 ΙAR 5,358,925 10/25/94 Neville Connell et al. AS 02/28/95 Summerfelt ΑT 5,393,352 ΑU 5,418,216 05/23/95 Fork ΑV 5,450,812 09/19/95 McKee et al. ΑW 5,478,653 12/26/95 Guenzer 5,482,003 01/09/96 McKee et al. 5,514,484 05/07/96 Nashimoto 5,556,463 09/17/96 Guenzer 12/31/96 Sheldon BA 5,588,995 5,670,798 Schetzina BB 09/23/97 03/31/98 Fork et al. 5,733,641 BC 5,735,949 04/07/98 Mantl et al. BD Ramdani et al. BE 5,741,724 04/21/98 5,810,923 09/22/98 Yano et al. BF McKee et al. BG 5,830,270 11/03/98 5,912,068 06/15/99 Jia ВН 6,020,222 02/01/00 Wollesen BI BJ 04/04/00 Yano et al. 6,045,626 05/16/00 Northrup et al. ВK 6,064,078 05/16/00 Park 6,064,092 BL ВМ 6,096,584 08/01/00 Ellis-Monaghan et al. McKee et al. BN 6,103,008 08/15/00 BO 6,136,666 10/24/00 So 01/16/01 Manning 6,174,755 ва 6,180,486 01/30/91/ eobandung et al.

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Form PTO 1449 (Modified)	P	U.S. DEPARTMENT OF COMM	ERCE CE	ATTY DOCKET NO.		SERIAL I	
	•		•	248412US99DIV APPLICANT		l	10/767,998
LIST OF	REFE	RENCES CITED BY APP	LICANT	1	AMDANI,	et al.	- —
	_	. == - · · · ·		FILING DATE	- , ***	GROUP	
				February 2, 2004		<u> </u>	2815
				U.S. PATENT DOCUMENTS			
XAMINER	<u> </u>	DOCUMENT	DATE	NAME	CLASS	SUB	FILING DATE
ANITIAL	CA	NUMBER	10/16/73	Walther	 	CLASS	IF APPROPRIATE
$U \times W = U$	CB	4,006,989	02/08/77	Andringa	-	<u> </u>	
	CC	4,284,329	08/18/81	Smith et al.	-		
	CD		10/11/98	Shahan et al.	ļ	<u> </u>	
		4,777,613	<u></u>			<u> </u>	/
	CE	4,802,182	01/31/89	Thornton et al.	ļ	ļ	
	CF	4,882,300	11/21/89	Inoue et al.	ļ		/
	CG	4,896,194	01/23/90	Suzuki	ļ		
	СН	4,999,842	03/12/91	Huang et al.			
	C	5,081,062	01/14/92	Vasudev et al.			
	3	5,155,658	10/13/92	Inam et al.			
	СК	5,248,564	09/28/93	Ramesh			
	CL	5,260,394	11/09/93	Tazaki et al.			1
	СМ	5,270,298	12/14/93	Ramesh			
	CN	5,286,985	02/15/94	Taddiken			1
	co	5,310,707	05/10/94	Oishi et al.			1
	СР	5,326,721	07/05/94	Summerfelt			
- 	ca	5,404,581	04/04/95	Honjo		/	
	CR	5,418,389	05/23/95	Watanabe		 /	
	cs	5,436,759	07/25/95	Dijali et al.		 	
	СТ	5,576,879	11/19/96	Nashimoto		/	
	CU	5,606,184	02/25/97	Abrokwah, et al.		/-	
	CV	5,640,267	06/17/97	May et al.	-	 	
	cw	5,674,366	10/07/97	Hayashi et al.		l /	
	СХ	5,729,641	03/17/98	Chandonnet et al.		 /	
	CY	5,790,583	08/04/98	Но	 	 	
L_1	cz	5,825,799	10/20/98	Ho et al.		 	
	DA	5,857,049	01/05/99	Beranek et al.	 	 	
	DB	5,874,860	02/23/99	Brunel et al.	<i> </i>	 	
	DC	5,926,496	07/20/99	Ho et al.	 		
	L	5,926,496		Abrokwah, et al.	 		
	DD	1'	08/10/99		 	 	
	DE	5,981,400	<u> </u>	Lo	$\vdash \vdash$	 	
	DF	5,990,495	11/23/99	Ohba		ļ	
	DG	6,002,375	12/14/99	Corman et al.			
	DH	6,008,762	12/28/99	Nghiem	 		
	DI	6,055,179	04/25/00	Koganei et al.	1		
	Dì	6,107,653	08/22/00	Fitzgerald	14-	ļ	
	DK	6,113,690	09/05/00	Yu et al.	<i> </i>		
	DL	6,114,996	09/05/00	Nghiem	Ш		
	DМ	6,121,642	09/19/00	Newns	Ш	ļ	
	DN	6,128,178	10/03/00	Newns	I V		
	DO	6,143,072	11/07/00	McKee et al.			
	DP	6,184,144	02/06/01	No Frigo /			
1	i		04/24/01				

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Form PTO 1449		U.S. DEPARTMENT OF COMM		ATTY DOCKET NO.		SERIAL	NO
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LISTOF	KEFE	RENCES CITED BY APP	LICANT	FILING DATE	RAMDAN	GROUP	
				February 2, 2004	2815		
				U.S. PATENT DOCUMENTS			
XAMINER	Γ	DOCUMENT	DATE	NAME	CLASS	SUB CLASS	FILING DATE
NITIAL	EA	NUMBER 4,484,332	11/20/84	Hawrylo	 	CLASS	IF APPROPRIATE
WIND	EB	4,815,084	03/21/89	Scifres et al.		 	
		4,876,219	10/24/89	Eshita et al.		 	
	EC	1			-	ļ	
	ED	4,963,508	10/16/90	Umeno et al.		 	
	EE	5,060,031	10/22/91	Abrokwah, et al.			
	EF	5,063,166	11/05/91	Mooney et al.	-		
	EG	5,116,461	05/26/92	Lebby et al.		ļ	ļ
	EH	5,127.067	06/30/92	Delcoco et al.		<u> </u>	
	EI	5,144,409	09/01/92	Ma		_	
	EJ	5,293,050	03/08/94	Chapple-Sokol et al	<u> </u>	_	
	EK	5,356,831	10/18/94	Calviello et al.			
	EL	5,391,515	02/21/95	Kao et al.	<u> </u>	ļ	
	EM	5,442,191	08/15/95	Ma			
	EN	5,444,016	08/22/95	Abrokwah, et al.			
	ΕO	5,480,829	01/02/96	Abrokwah, et al.			
	EΡ	5,528,414	06/18/96	Oakley		<u> </u>	
	EQ	5,614,739	03/25/97	Abrokwah et al.			L
	ER	5,729,394	03/17/98	Sevier et al.			
	ES	5,731,220	03/24/98	Tsu et al.		_	
<u> </u>	ET	5,764,676	06/09/98	Paoli et al.			
	EU	5,777,762	07/07/98	Yamamoto			
	ΕV	5,778,018	07/07/98	Yoshikawa et al.			
	EW	5,778,116	07/07/98	Tomich			
	EX	5,801,105	09/01/98	Yano et al.			
	EY	5,828,080	10/27/98	Yano et al.		1 7	
	EZ	5,858,814	01/12/99	Goossen et al.			
	FA	5,861,966	01/19/99	Ortel			
	FB	5,883,996	03/16/99	Knapp et al.			
	FC	5,995,359	11/30/99	Klee et al.	1	11	
	FD	6,058,131	05/02/00	Pan		17	
	FE	6,137,603	10/24/00	Henmi			
	FF	6,146,906	11/14/00	Inoue et al.			
	FG	6,173,474	01/16/01	Conrad		17	
	FH	6,180,252	01/30/01	Farrell et al.		11	
\neg	FI	4,242,595	12/30/0	Lehovec		1/	
	FJ	4,398,342	08/16/83	Pitt et al.	1	1/	
	FK	4,424,589	01/03/84	Thomas et al.		1	
	FL	4,876,208	10/24/89	Gustafson et al.	1	1	
	FM	4,482,422	11/84	McGinn et al.		/	
	FN	4,667,088	05/19/87	Kramer		/	
- 	FO	4,772,929	09/20/88	Manchester et al.	1 1	1	
-1/	FP	4,841,775	06/27/89	ikeda et al./	1- 1	1	
	FQ	4,845,044	07/04/89	Ariyashi eyal.	1 1	†	

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Form PTO 14 (Modified)		U.S. DEPARTMENT OF COM PATENT AND TRADEMARK OF	MERCE FICE	ATTY DOCKET NO. 248412US99DIV		SERIAL I	NO. 10/767,998
LIST 4	ne peer	DENICES OFFER BY AS	DDI ICANT	APPLICANT	DAMDAN	l ot al	
LIST	JF KEFE	ERENCES CITED BY AF	PEICANI	FILING DATE	RAMDAN	GROUP	
				February 2, 2004		GROOF	2815
-VALUE		T BOOLINGS IT	DATE	U.S. PATENT DOCUMENTS NAME	CLASS	SUB	FILING DATE
EXAMINE INITIAL		DOCUMENT NUMBER	DATE		CLASS	CLASS	IF APPROPRIATE
BVM	GA	4,868,376	09/19/89	Lessin et al.			
	GB	4,885,376	12/05/89	Verkade			/'
	GC	4,888,202	12/89	Murakami et al.			
	GD	4,891,091	12/90	Wanlass et al.			
	GE	5,051,790	09/24/91	Hammer			
	GF	5,055,445	10/08/91	Belt et al.	1		
	GG	5,081,519	11/14/92	Nishimura et al.			
	GH	5,143,854	09/01/92	Pirrung et al.			· /
	Gi	5,185,589	02/09/93	Krishnaswamy et al.			/
	GJ	5,191,625	03/02/93	Gustavsson			
	GK	5,194,397	03/16/93	Cook et al.			/
	GL	5,208,182	05/04/93	Narayan et al.			/
	GM	5,216,729	06/01/93	Berger et al.			
	GN	5,314,547	05/24/94	Heremans et al.			
	GO	5,352,926	10/04/94	Andrews			
	GP	5,356,509	10/18/94	Terranova et al.		\top	
	GQ	5,371,734	12/06/94	Fischer			
	GR	5,372,992	12/94	Itozaki et al.			
	GS	5,405,802	04/11/95	Yamagata et al.		TT	·
	GT	5,442,561	08/15/95	Yoshizawa et al.		$\top I$	
	GU	5,453,727	09/26/95	Shibasaki et al.			
	G۷	5,466,631	11/14/95	ichikawa et al.		TT_{-}	
	GW	5,473,047	12/05/95	Shi			
	GX	5,473,171	12/95	Summerfelt			
	GY	5,479,033	12/26/95	Baca et al.			
	GZ	5,486,406	01/23/96	Shi			
	HA	5,491,461	02/13/96	Partin et al.		\prod	
	НВ	5,492,859	02/20/96	Sakaguchi et al.		\mathcal{I}	
	нс	5,494,711	02/27/96	Takeda et al.			
	HD	5,504,035	04/02/96	Rostoker et al.			
	HE	5,504,183	04/02/96	Shi			
	HF	5,511,238	04/23/96	Bayraktaroglu			
	HG	5,512,773	04/96	Wolf et al.		Ц	
	НН	5,515,047	05/07/96	Yamakido et al.			
	н	5,515,810	05/14/96	Yamashita et al.			
	HJ	5,519,235	05/96	Ramesh			
1	нк	5,549,977	08/96	Jin et al.			
	HL	5,551,238	09/03/96	Prueitt	$\Box \Box \Box$		
	НМ	5,552,547	09/03/96	Shi	$\perp T$		
$\neg \uparrow$	HN	5,589,284	12/31/96	Summerfelt et al.			
1//	НО	5,602,418	02/11/97	lmai et al.			
- 11 /	НР	5,633,724	05/27/97	King et al.			

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Form PTO 1449 U.S. DEPARTMENT OF COMMERCE (Modified) PATENT AND TRADEMARK OFFICE				ATTY DOCKET NO. 248412US99DIV		SERIAL	NO. 10/767,998
				APPLICANT		·	10/10/,030
LIST OF	REFE	ERENCES CITED BY AP	PLICANT		RAMDANI,	et al.	
				FILING DATE		GROUP	
			 	February 2, 2004			2815
				U.S. PATENT DOCUMENTS			
EXAMINER		DOCUMENT	DATE	NAME	CLASS	SUB	FILING DATE
MA B	IA	NUMBER 5,650,646	07/22/97	Summerfelt	 	CLASS	IF APPROPRIATE
BNB	IB	5,656,382	08/12/97	Nashimoto	+	 	
	IC	5,659,180	08/19/97	Shen et al.		 	/-
	ID	5,661,112	08/26/97	Hatta et al.		 	
	ΙE	5,679,965	11/95	Schetzina			/
	1F	5,725,641	03/10/98	MacLeod	+	 	
	IG	5,745,631	04/28/98	Reinker	+		/
	IH	5,776,621	07/07/98	Nashimoto	 		
	ii ii	5,777,350	07/07/98	Nakamura et al.	 	 	
	ij i	5,789,845	08/04/98	Wadaka et al.	+	 	
	IK	5,792,569	08/11/98	Sun et al.	+		
- -	IL.	5,792,679	08/11/98	Nakato		 	/
+	IM .	5,796,648	08/18/98	Kawakubo et al.	 	 	/
 	IN	5,801,072	09/01/98	Barber	+	 	
	10	5,812,272	09/22/98	King et al.	<u> </u>	 / 	
+	IP	5,814,583	09/98	Itozaki et al.	-	 	
	IQ	5,825,055	10/20/98	Summerfelt	 	/-	
	IR	5,827,755	10/20/98	Yonchara et al.	 	 	
-	IS	5,833,603	11/10/98	Kovacs et al.	 	 	
	IT	5,838,035	11/17/98	Ramesh	-	 /	
	IU I	5,844,260	12/01/98	Ohori		 /	
1	IV	5,846,846	12/08/98	Suh et al.		 	
	lw	5,863,326	01/26/99	Nause et al.	 /	 	
+	IX	5,872,493	02/16/99	Ella		 	
 	IY	5,879,956	03/99	Seon et al.	/-		
 	IZ	5,880,452	03/09/99	Plesko	 /-		
 	JA	5,883,564	03/05/99	Partin	+-/-	 	
1	JB	5,907,792	05/25/99	Droopad et al.	 	 	
1	nc PB	5,937,274	08/10/99	Kondow et al.	+-	 	
	ND OF	5,948,161	09/07/99	Kizuki	+/	 	
+	JE	5,959,879	09/28/99	Koo	++		
-	JF	5,966,323	10/99	Chen et al.	+		
/ \ 	JG	5,987,011	11/16/99	Toh			
 	JH	6,022,140	02/08/00	Fraden et al.			
	71	6,022,410	02/08/00	Yu et al.	 	 	-
	77	6,023,082	02/08/00	McKee et al.	-	 	
	JK	6,028,853	02/22/00	Haartsen	1	 	
	Nr.	6,049,702	04/11/00	Tham et al.	 	 	
	JM	6,078,717	06/20/00	Nashimoto et al	#		
	NN PINI	6,088,216	07/00	Laibowitz et al.	-		
- 	no PM	6,090,659	07/00	Laibowitz et al.	 		
- "\ / -	JP	6,107,721	08/22/00	Lakin	 		
	JQ	6,153,010	/11/28/00	Kiyoku et al	 		
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LIST OF	REFE	RENCES CITED BY AP	LFICWII	FILING DATE	AWUA	VI, et al. GROU	P		
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EXAMINER	Τ	DOCUMENT	DATE	U.S. PATENT DOCUMENTS NAME	CLAS	s I sub	FILING DATE		
INITIAL		NUMBER	144100100			CLAS	S IF APPROPRIATE		
13/N13	KA	6,153,454	11/28/00	Krivokapic			_ /		
	КВ	6,191,011	02/01	Gilboa et al	_				
	кс	6,204,737	03/20/01	Ella					
	KD	6,224,669	05/01/01	Yi et al.		_	<u> </u>		
	KE	6,225,051	05/01/01	Sugiyama et al.	_		 		
	KF	6,241,821	06/05/01	Yu et al.	.				
	KG	6,265,749	07/24/01	Gardner et al.			 		
	кн	6,313,486	11/01	Kencke et al.					
	KI	6,316,832	11/13/01	Tsuzuki et al.					
	KJ	2002/0008234	01/02	Emrick					
	KK	3,670,213	06/13/72	Nakawaga et al.					
	KL	4,756,007	07/05/88	Qureshi et al.			1/		
	КМ	4,773,063	09/20/88	Hunsperger et al.					
	KN	5,394,489	02/28/95	Koch			1/		
	ко	5,406,202	04/11/95	Mehrgardt et al.			_		
	KP	5,528,067	06/18/96	Farb et al.			1/		
	KQ	5,572,052	11/05/96	Kashihara et al.					
	KR	5,767,543	06/16/98	Ooms et al.					
	KS	6,175,497	01/16/01	Tseng et al.			/		
	KT	6,197,503	03/06/01	Vo-Dinh et al.			/		
	ΚU	6,248,459	06/19/01	Wang et al.			<u> </u>		
	ΚV	6,252,261	06/26/01	Usui et al.					
	kw	6,255,198	07/03/01	Linthicum et al.					
	кx	6,268,269	07/31/01	Lee et al.					
	KY	6,291,319	09/18/01	Yu et al.		17			
	ΚZ	6,316,785	11/13/01	Nunoue et al.		/			
1	LA	6,343,171	01/29/02	Yoshimura et al.		-			
	LB	4,965,649	10/23/90	Zanio et al.					
	LC	6,253,649	05/01	Kawahara et al.					
	LD	6,211,096	04/01	Allman et al.		11			
	LE	6,239,449	05/29/01	Fafard et al.		Ш			
1	LF	2001/0013313	08/16/01	Droopad et al.					
	LG	6,184,044	02/06/01	Sone et al.					
	LH	6,011,646	01/04/00	Mirkarimi et al.					
	LI	5,227,196	07/13/93	Itoh					
	ш	6,150,239	11/21/00	Goesele et al.					
	LK	5,441,577	08/15/95	Sasaki et al.					
	LL	4,459,325	07/10/84	Nozawa et al.					
	LM	4,392,297	07/12/83	Little					
	LN	4,289,920	09/15/81	Hovel					
	ГО	5,281,834	01/25/94	Cambou et al.	11	1			
1 7	LP	4,901,133	02/13/90	Curran et al.	17				
/\ /	LQ	5,514,904	05/07/95	Opgalet al.	11				
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(Modified)	PA	TENT AND TRADEMARK OFFIC	Ε	248412US99DIV		<u> </u>	10/767,998	
LIST OF	RFFF	RENCES CITED BY APP	LICANT	APPLICANT	AMDANI,	et al		
Lioi Oi		CHOCS CHED BY AFF	LICAN	FILING DATE	AIVIDAINI,	GROUP		
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				U.S. PATENT DOCUMENTS	, .	, -		
EXAMINER INITIAL A		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE	
mly	MA	5,553,089	09/03/96	Seki et al.				
1000	МВ	5,528,057	06/18/96	Yanagase et al.				
	МС	6,229,159	05/08/01	Suzuki				
	MD	4,748,485	05/31/88	Vasudev				
	ME	4,984,043	01/08/91	Vinal				
	MF	5,754,319	05/19/98	Van De Voorde et al.				
	MG	6,108,125	08/22/00	Yano				
	МН	5,073,981	12/17/91	Giles et al.				
	MI	5,140,651	08/18/92	Soref et al.				
	MJ	5,610,744	03/11/97	-Ho et al.	<u> </u>			
- - 	MK	6,362,017	03/26/02	Manabe et al.				
	ML	6,242,686	06/05/01	Kishimoto et al.	 			
	ММ	5,689,123	11/18/97	Major et al.			- 	
	MN	5,670,800	09/23/97	Nakao et al.			1	
	МО	5,067,809	11/26/91	Tsubota	 		 	
	MP	5,596,205	01/21/97	Reedy et al.			 	
	MQ	6,175,555	01/16/01	Hoole			 	
	MR	5 ,357,122	10/18/94	Okubora et al.			·	
	MS	4,084,130	04/11/78	Holton		/		
	MT	6,093,302	07/25/00	Montgomery		/1		
	MU	6,372,813	04/16/02	Johnson et al.		/ /		
	MV	5,608,046	03/04/97	Cook et al.		<i></i>	· · · · · · · · · · · · · · · · · · ·	
	MW	5,955,591	09/21/99	Imbach et al.		/ 		
	MX	6,022,963	02/08/00	McGall et al.				
	MY	6,083,697	07/04/00	Beecher et al.		/	······································	
	MZ	5,063,081	11/05/91	Cozzette et al.		/		
	NA	5,479,317	12/26/95	Ramesh				
	NB	5,306,649	04/26/94	Hebert				
	NC	5,962,069	10/05/99	Schindler et al.				
	ND	5,541,422	07/30/96	Wolf et al.				
	NE	5,873,977	02/23/99	Desu et al.				
	NF	5,538,941	07/23/96	Findikoglu et al.				
	NG	6,046,464	04/04/00	Schetzina				
	NH	6,235,145	05/22/01	Li et al.				
	NI	5,610,744	03/11/97	Ho et al.				
	NJ	5,280,013	01/18/94	Newman et al.				
	NK	6,348,373 B1	02/19/02	Ma et al.				
	NL	6,339,664 B1	01/15/02	Farjady et al.				
	NM	4,439,014	03/27/84	Stacy et al.				
	NN	4,889,402	12/26/89	Reinhart				
	NO	5,963,291	10/05/99	Wu et al.				
	NP	6,011,641	01/04/90	Shin et al.				
\	NQ	6,340,788 B1	01/22/02	King et al.				

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Form PTO 1449	-	U.S. DEPARTMENT OF COMM		ATTY DOCKET NO.		SERIAL		
(Modified)	PA	TENT AND TRADEMARK OFF	CE	248412US99DIV			10/767,998	
LIST OF	REFER	RENCES CITED BY API	PLICANT	APPLICANT Jamal R	, et al.			
				FILING DATE		GROUP		
				February 2, 2004		2815		
	,	· · · · · · · · · · · · · · · · · · ·	1	U.S. PATENT DOCUMENTS	<u> </u>	_:		
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE/ IF APPROPRIATE	
made	OA	5,807,440	09/15/98	Kubota et al.				
wite	ОВ	4,681,982	07/21/87	Yoshida				
<u> </u>	ОС	4,629,821	12/16/86	Bronstein-Bonte et al.				
-	OD	4,452,720	06/05/84	Harada et al.				
	OE	3,935,031	01/27/76	Adler	<u> </u>			
	OF	5,760,426	06/02/98	Marx et al.				
	OG	5,053,835	10/01/91	Horikawa et al.			· /	
	ОН	6,326,645 B1	12/04/01	Kadota				
	Ol	5,770,887	06/23/98	Tadatomo et al.				
	O1	6,372,356 B1	04/16/02	Thornton et al.				
	ОК	4,774,205	09/27/88	Chol et al.				
1	OL	6,359,330 B1	03/19/02	Goudard				
	ОМ	5,312,765	05/17/94	Kanber				
	ON	5,734,672	03/31/98	McMinn et al.				
	00	6,367,699 B2	04/09/02	Ackley				
	OP	5,530,235	06/25/96	Stefik et al.				
	ΟQ	5,623,552	04/22/97	Lane			/	
	OR	5,481,102	01/02/96	Hazelrigg, Jr.				
	os	6,134,114	10/17/00	Ungermann et al.				
	ОТ	5,984,190	11/16/99	Nevill				
	ου	5,789,733	08/04/98	Jachimowicz et al.				
	ΟV	5,753,300	05/19/98	Wessels et al.				
	ow	6,208,453	03/27/01	Wessels et al.				
	ОХ	5,886,867	03/23/99	Chivukula et al.				
	OY	5,028,976	07/02/91	Ozaki et al.				
	OZ	5,869,845	02/09/99	Vander Wagt et al.				
	PA	5,596,214	01/21/97	Endo				
	РВ	6,391,674 B2	05/21/02	Ziegler				
	PC	6,275,122 B1	08/14/01	Speidell et al.				
	PD	6,238,946 B1	05/29/01	Ziegler				
	PE	6,210,988 B1	04/03/01	Howe et al.				
	PF	6,392,257	05/21/02	Ramdani et al.				
	PG	4,442,590	04/17/84	Stockton et al.	$\perp I$			
	РН	5,603,764	02/18/97	Matsuda et al.				
	PI	6,087,681	06/11/00	Shakuda		ļ		
	PJ	5,132,648	07/21/92	Trinh et al.				
	PK	6,427,066	07/30/02	Grube		<u> </u>		
	PL	2002/0072245	06/13/02	Ooms et al.	$\perp 1$	<u> </u>		
	РМ	6,278,138 B1	08/21/01	Suzuki		<u> </u>		
	PN	5,888,296	03/30/99	Ooms et al.				
	PO	5,198,269	03/3093	Swartz et al.	1/1			
	PP	2002/0030246	03/14/02	Eisenbeiser et al.	1/1			
7/	PQ	2002/0047148	04/25/02	Ramdan et al.	V	1		

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Form PTO 1449		U.S. DEPARTMENT OF COMME	RCE	ATTY DOCKET NO.		SERIAL	NO.
(Modified)	PA	TENT AND TRADEMARK OFFIC		248412US99DIV	-		10/767,998
LIST OF	REFF	RENCES CITED BY APP	LICANT	APPLICANT Jamal R	AMDANI	et al	
	•	(FILING DATE	1111 <i>07</i> 1111,	GROUP	
				February 2, 2004			2815
				U.S. PATENT DOCUMENTS			
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
BNB	QA	5,776,359	07/07/98	Schultz et al.			
77	QB	5,569,953	10/29/96	Kikkawa et al.			/
	QC	5,834,362	11/10/98	Miyagaki et al.			
	QD	6,248,621 B1	06/19/01	Wilk et al.			
	QE	5,266,355	11/30/93	Wernberg et al.			
	QF	6,277,436 B1	08/21/01	Stauf et al.			
	QG	6,039,803	03/21/00	Fitzgerald et al.			/
	QH	5,619,051	04/08/97	Endo			1
	QI	5,420,102	05/30/95	Harshavardhan et al.			/
	QJ	5,210,763	05/11/93	Lewis et al.			
	QK	5,103,494	04/07/92	Mozer			
	QL	4,594,000	06/10/86	Falk et al.		-	
	QM	4,297,656	10/27/81	Pan			
	QN	5,244,818	09/14/93	Jokers et al.			1
	QO	6,048,751	04/11/00	D'Asaro et al.			1
	QP	5,484,664	01/16/96	Kitahara et al.			1
	QQ	5,780,311	07/14/98	Beasom et al.			/
	QR	6,438,281 B1	08/20/02	Tsukamoto et al.			/
	QS	5,399,898	03/21/95	Rostoker		 	
-	QT	6,271,619	08/07/01	Yamada et al.		 /	
	αυ	5,334,556	08/02/94	Guldi		 	
	۵۷	4,910,164	03/20/90	Shichijo		 	
	QW	4,952,420	08/28/90	Walters		/	
	QΧ	6,121,647	09/19/00	Yano et al.		 	
	§ Y	6,306,668 B1	10/23/01	McKee et al.		 	
	QZ	6,143,366	11/07/00	Lu		 	
` 	RA	6,410,941	06/25/02	Taylor et al.		/ 	
	RB	5,397,428	03/14/95	Stoner et al.		 	
	RC	6,432,546 B1	08/13/02	Ramesh et al.		 	
	RD	6,345,424	02/12/02	Hasegawa et al.	 /		
- + - 	RE	6,338,756 B2	02/12/02	Dietze	 		
 	RF	5,516,725	05/14/96	Chang et al.	<i> </i> -		
	RG	4,667,212	05/19/87	Nakamura	 /-		
	RH	5,629,534	05/13/97	Inuzuka et al.	/-		
	RI	3,914,137	10/21/75	Huffman et al.	 		
	RJ	5,753,928	05/19/98	Krause			
	RK	5,977,567	11/02/99	Verdiell	 -		
 	RL	5,130,762	07/14/92	Kulick			
	RM	5,621,227	04/15/97	Joshi	 		
- , - 	RN	6,389,209 B1	05/14/02	Suhir	l- /		
	RO	5,163,118	11/10/92	Lorenzo et al.			
 	RP	5,926,493	07/20/99	O'Brien et al.	 		
							
	RQ	5,323,023	06/21/94	Fork	4		<u> </u>

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Form PTO 1449 (Modified)		U.S. DEPARTMENT OF COMME TENT AND TRADEMARK OFFIC		ATTY DOCKET NO. 248412US99DIV		SERIAL	NO. 10/767,998	
				APPLICANT				
LIST OF	REFER	RENCES CITED BY APPI	LICANT	Jamal R	AMDAN			
				FILING DATE February 2, 2004		GROUP	2815	
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EXAMINER INITIAL	-	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE	
Bush	SA	6,156,581	12/05/00	Vaudo et al.		1		
	SB	5,395,663	03/07/95	Tabata et al.				
	sc	4,146,297	03/27/79	Alferness et al.				
	SD	5,452,118	09/19/95	Maruska			7	
	SE	5,889,296	03/30/99	Imamura et al.	1		7	
	SF	6,300,615 B1	10/09/01	Shinohara et al.			7	
	SG	6,232,910 B1	05/15/01	Bell et al.		1	7	
	SH	5,686,741	11/11/97	Ohori et al.	İ	1	7	
	SI	4,959,702	09/25/90	Moyer et al			/	
	SJ	6,100,578	08/08/00	Suzuki			/	
	SK	6,410,947 B1	06/25/02	Wada		···-	/	
	SL	6,417,059 B2	07/09/02	Huang	1		/	
	SM	6.461,927 B1	10/08/02	Mochizuki et al.	1			
	SN	6,462,360 B1	10/08/02	Higgins, Jr. et al.	 	†		
	so	5,981,976	11/09/99	Murasato			/	
	SP	5,981,980	11/09/99	Miyajima et al.			 	
	SQ	2002/0006245 A1	01/17/02	Kubota et al.	<u> </u>	 	/	
	SR	2002/0131675 A1	09/19/02	Litvin		-	/	
	SS	6,256,426 B1	07/03/01	Duchet	<u> </u>	 	/	
	ST	6,278,523 B1	08/21/01	Gorecki	-	· ·		
	SU	6,319,730 B1	11/20/01	Ramdani et al.	 	1 /		
	sv	6,404,027	06/11/02	Hong et al.	 	 		
	sw	6,312,819 B1	11/06/01	Jia et al.		 		
	sx	5,119,448	06/02/92	Schaefer et al.	 	 		
	SY	4,120,588	10/17/78	Chaum	 	 		
	sz	5,194,917	03/16/93	Regener		 / 		
	TA	5,018,816	05/28/91	Murray et al.	 	+/		
	ТВ	5,953,468	09/14/99	Finnila et al.	1	+/-		
	TC	5,561,305	10/01/96	Smith	 	 /		
	TD	5,896,476	04/20/99	Wisseman et al.	 	 		
	TE	4,934,777	06/19/90	Jou et al.	 	1		
 	TF	6,320,238 B1	11/20/01	Kizilyalli et al.	 - 	/		
	TG	6,393,167 B1	05/21/02	Davis et al.	 			
	TH	5,760,427	06/02/98	Onda	 	 		
 -	TI	6,411,756 B2	06/25/02	Sadot et al.	 	1		
	TJ	5,668,048	09/16/97	Kondo et al.	 	 		
	TK	5,852,687	12/22/98	Wickham	 	 		
	TL	5,122,852	06/16/92	Chan et al.	+ +	†		
	TM	5,173,835	12/22/92	Cornett et al.	 	 	 	
 	TN	5,055,835	10/08/91	Sutton	 	 	 	
	TO	6,139,483	10/31/00	Seabaugh et al.	 	 	 	
 	ΤP	5,283,462	02/01/94	Stengel	++-	 	 	
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\ <i> </i> /	TQ	6,103,403	08/15/00//	Grigorian et al.	1-	<u> </u>	l	

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(Modified)	PA	U.S. DEPARTMENT OF COMME TENT AND TRADEMARK OFFIC	E	248412US99DIV		SERIAL	10/767,998		
UST OF	REFER	RENCES CITED BY APPI	LICANT	APPLICANT Jamai RAMDANI,			et al.		
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				February 2, 2004			2815		
				U.S. PATENT DOCUMENTS					
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE		
MAD	UA	5,635,433	06/03/97	Sengupta					
	UB	5,427,988	06/27/95	Sengupta et al.					
	UC	6,297,842 B1	10/02/01	Koizumi et al.					
	UD	5,682,046	10/28/97	Takahashi et al.					
	UE	5,181,085	01/19/93	Moon et al.					
	UF	6,051,858	04/18/00	Uchida et al.					
	UG	6,013,553	01/11/00	Wallace et al.					
	UH	4,872,046	10/03/89	Morkoc et al.					
_	UI	2002/0047123 A1	04/25/02	Ramdani et al.			/		
	บม	5,995,528	11/30/99	Fukunaga et al.			7		
	UK	5,075,743	12/24/91	Behfar-Rad			/		
	UL	5,438,584	08/01/95	Paoli et al.	<u> </u>				
	UM	4,503,540	03/05/85	Nakashima et al.		/			
	UN	5,373,166	12/13/94	Buchan et al.					
	UO	6,278,137 B1	08/21/01	Shimoyama et al.		/			
	UP	5,623,439	04/22/97	Gotoh et al.					
	UQ	4,981,714	01/01/91	Ohno et al.	/				
	UR	6,194,753 B1	02/27/01	Seon et al.	 				
	US	6,326,637 B1	12/04/01	Parkin et al.	/	_			
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				248412US99DIV APPLICANT	10/767,998
LIST OF	REFE	RENCES CITED BY AP	PLICANT	Jamal RAMD	
				FILING DATE	GROUP
				February 2, 2004	2815
	т	DOCUMENT	DATE	U.S. PATENT DOCUMENTS COUNTRY	TRANSLATION
		NUMBER	DATE	COUNTRY	
					YES NO
BWOD	AAA	0 250 171	12/23/87	EP	X
<u> </u>	AAB	0 342 937	11/23/89	EP	×
1	AAC	0 455 526	06/11/91	EP	×
		0 602 568	06/22/94	EP	X
		0 607 435	07/27/94	EP	×
	AAF	1 001 468	05/17/00	EP	×
	AAG	0 514 018	11/19/92	EP	×
	AAH	0 999 600	05/10/00	EP	X
	AAI	1 319 311	06/04/70	Great Britain	×
	AAJ	5-291299	11/05/93	Japan w/English Abstract	×
	AAK	11-238683	08/31/99	Japan	×
	AAL	11-260835	09/24/99	Japan w/English Abstract	X
		HEI 2-391	01/05/90	Japan w/English Abstract	X
	AAN	5-48072	02/26/93	Japan w/English Abstract	×
	AAO	52-88354	07/23/77	Japan w/English Abstract	×
	AAP	54-134554	10/19/79	Japan w/English Abstract	×
	AAQ	55-87424	07/02/80	Japan w/English Abstract	×
	AAR	61-108187	05/26/86	Japan w/English Abstract	×
	AAS	6-232126	08/19/94	Japan	X
	AAT	6-291299	10/18/94	Japan w/English Abstract	X
	AAU	63-34994	02/15/88	Japan w/English Abstract	X
	AAV	63-131104	06/03/88	Japan w/English Abstract	X
	1	63-198365	08/17/88	Japan w/English Abstract	X
		10-321943	12/04/98	Japan	X
	AAY	6-334168	12/02/94	Japan	X
	AAZ	WO 99/63580	12/09/99	WIPO	X
	ABA	WO 99/14804	03/25/99	WIPO	X
	ABB	WO 97/45827	12/04/97	WIPO	
	ABC	WO 99/19546	04/22/99	WIPO	
	ABD	WO 00/33363	06/08/00	WIPO	
	ABE	WO 00/48239	08/17/00	WIPO	
	ABF	WO 99/14797	03/25/99	WIPO	
	ABG	GB 2 335 792	09/29/99	Great Britain	
	ABH	1 109 212	06/20/01	Europe	
	ABI	DE 197 12 496	10/30/97	Germany	×
	ABJ	60-212018	10/24/85	Japan w/English Abstract	
<u> </u>	ABK	60-210018	10/22/85	Japan w/English Abstract	/
<u> </u>	ABL	WO 92/10875	06/25/92	WIPO	/_
	ABM	0 682 266	11/15/95	Europe	
	ABN	3-41783	02/91	Japan (English Abstract only)	/
	ABO	0 581 239	02/02/94	Europe	
/	ABP	0812494	01/16/96	Japan /	
<u> </u>	ARG	2 000 1645	06/16/00	i/3/05	

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Form PTO 1449 Modified)		U.S. DEPARTMENT OF COMI ATENT AND TRADEMARK OFF		ATTY DOCKET NO. 248412US99DIV	SERIAL NO. 10/767,998
LISTO	e Dece	DENCES CITED BY AD	DUCANT	APPLICANT In The I DAME	
LISTO	r KEFE	RENCES CITED BY AP	PLICANI	Jamai RAMI	GROUP
				February 2, 2004	2815
				U.S. PATENT DOCUMENTS	
		DOCUMENT	DATE	COUNTRY	TRANSLATION
		NUMBER			YES NO
Han 1	BAA	1 043 426	10/11/00	Europe	
10 this	BAB	2000-068466	03/00	Japan (Abstract)	
	BAC	64-50575	02/27/89	Japan	
	BAD	WO 98/05807	01/12/98	WIPO	
	BAE	WO 94/03908	02/17/94	WIPO	<u> </u>
- -	BAF	WO 01/33585	05/10/01	WIPO	
	BAG	1-102435	04/20/89	Japan w/English Abstract	
	ВАН	52-135684	11/12/77	Japan (English Abstract)	
_	BAI	02051220	02/21/90	Japan (English Abstract)	
	BAJ	11135614	05/21/99	Japan (w/English Abstract)	/
	BAK	64-52329	02/28/89	Japan (w/English Abstract)	
	BAL	10-256154	09/25/98	Japan (w/English Abstract)	
	ВАМ	DE 196 07 107	08/28/97	Germany	XX
	BAN	10-303396	11/13/98	Japan (w/English Abstract)	
	BAO	58-213412	12/12/83	Japan w/English Abstract	
	BAP	0 964 259	12/15/99	Europe	
	BAQ	0 875 922	11/04/98	Europe	
	BAR	61-63015	04/01/86	Japan w/English Abstract	
	BAS	11340542	12/10/99	Japan (English Abstract)	
_	BAT	WO 01/37330	05/25/01	WIPO	
	BAU	0 331 467	09/06/89	Europe	-
	BAV	WO 00/16378	03/23/00	WIPO	
	BAW	0 926 739	06/30/99	Europe	
_	BAX	0 964 453	12/15/99	Europe	
	BAY	5-152529	06/18/93	Japan w/English Abstract	
	BAZ	9-67193	03/11/97	Japan w/English Abstract	
	ВВА	9-82913	03/28/97	Japan w/English Abstract	
_	ввв	0 309 270	03/29/89	Europe	
-	ввс	EP 0 957 522	11/17/99	Europe	
_	BBD	EP 0 810 666	12/03/97	Europe	
	BBE	1-179411	07/17/89	Japan w/English Abstract	
_	BBF	DE 100 17 137	10/26/00	GERMANY	
	BBG	WO 02 01648	01/03/02	WIPO	
	ввн	WO 02/33385 A2	04/25/02	WIPO	
	вві	WO 01/59814 A2	08/16/01	WIPO	
- -	ввл	WO 02/09160 A2	01/31/02	WIPO	<u> </u>
	ввк	WO 00/06812	02/10/00	WIPO	
	BBL	0 483 993	05/06/92	Europe	
	ввм	0 538 611	04/28/93	Europe	-
_	BBN	WO 01/59820 A1	08/16/01	WIPO	/
 -	вво	05150143	06/18/93	Japan (English Abstract only)	
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	вво	5-086477	04/06/93	Japan (English Abstract only)	

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Form PTO 1449 (Modified)	P	U.S. DEPARTMENT OF COMM ATENT AND TRADEMARK OFFI		ATTY DOCKET NO. 248412US99DIV	SERIAL NO.)/767,998
				APPLICANT 2464 120599DIV		n 1 U 1 1 3 3 U
LIST OF REFERENCES CITED BY APPLICANT		PLICANT	Jamai RAMDANI, et al.			
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	1	хо	4,723,321	02/02/88	SALEH			/	
		ΧP	6,181,920 B1	01/30/01	DENT ET AL			7	
		XQ	6,415,140 B1	07/02/02	BENJAMIN ET AL			/	
		XR	5,760,740	06/02/98	BLODGETT			7	
		XS	5,238,877	08/24/93	RUSSELL			/	
		XT	4,876,218	10/24/89	PESSA ET AL			/	
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		ΧV	4,378,259	03/29/83	HASEGAWA ET AL			/	
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		XZ	4,174,504	11/13/79	CHENAUSKY ET AL			1	
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		YC	6,140,746	10/31/00	MIYASHITA ET AL				
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		YO	5,362,998	11/08/94	IWAMURA ET AL				
		YP	5,188,976	02/23/93	KUME ET AL	1/			
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		YS	5,238,877	08/24/93	RUSSELL			
		YT	5,540,785	07/30/96	DENNARD ET AL			7
		YU	5,997,638	12/07/99	COPEL ET AL			7,
	1	77	6,291,866	09/18/01	WALLACE			
	1	YW	5,365,477	11/15/94	COOPER, JR ET AL			
	T^{-}	YX	5,548,141	08/20/96	MORRIS ET AL			
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	T	ZA	5,667,586	09/16/97	EK ET AL			
	 	ZB	5,313,058	05/17/94	FRIEDERICH ET AL	-		/
	\vdash	zc	5,315,128	05/24/94	HUNT ET AL	 	-	
		ZD	5,919,522	07/06/99	BAUM ET AL			1
		ZE	4,843,609	06/27/89	OHYA ET AL	<u> </u>		
	\vdash	ZF	4,626,878	12/02/86	KUWANO ET AL			1
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		ZH	3,818,451	06/18/74	COLEMAN			
	\vdash	ZI	6,059,895	05/09/00	CHU ET AL			
	Н	ZJ	4,447,116	05/08/84	KING ET AL		-/-	
		ZK	6,022,671	02/08/00	BINKLEY ET AL		/-	
		ZL	5,754,714	05/19/98	SUZUKI ET AL		-/- -	
	-	ZM	6,524,651 B2	02/25/03	GAN ET AL		-/	<u> </u>
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	Н			06/24/97	TOHYAMA ET AL		/	
		ZP	5,642,371 6,445,724 B2	09/03/02	ABELES	 		
	-		5,753,934	05/03/02	YANO ET AL	 		
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		CCC	2001-196892	07/19/01	JAPAN W/ENGLISH ABSTRACT			
		CCD	2000-278085	10/06/00	JAPAN (ENGLISH ABSTRACT)		i	
		CCE	WO 03/012874	02/13/03	WIPO			
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		ccw	198 29 609	01/05/00	GERMANY					
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